# PC3H5

#### **■** Features

- 1. Half pitch surface mount type for high density mounting (Lead pitch:1.27mm)
- 2. High sensitivity (darlington type)
- 3. Soldering reflow type (230°C, for 30s)
- 4. Taping package
- 5. Isolation voltage (Viso (rms):2.5kV)
- 6. Recognized by UL, file No. E64380

### ■ Applications

- 1. Programmable controllers
- 2. Facsimiles
- 3. Telephones

#### ■ Package Specifications

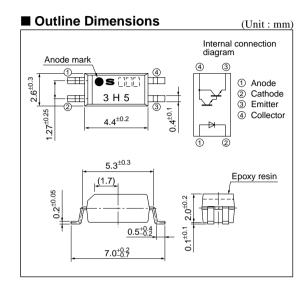
Model No.	Package specification
PC3H5	Taping reel diameter 330mm (3 000pcs.)

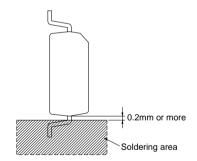
## ■ Absolute Maximum Ratings

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	Parameter	Symbol	Rating	Unit	
Input	*1 Forward current	IF	50	mA	
	*2 Peak forward current	IFM	1	A	
	Reverse voltage	$V_R$	6	V	
	*1 Power dissipation	P	70	mW	
Output	Collector-emitter voltage	Vceo	35	V	
	Emitter-collector voltage	Veco	6	V	
	Collector current	Ic	80	mA	
	*1 Collector power dissipation	Pc	150	mW	
*1 Total power dissipation		Ptot	170	mW	
Operating temperature		Topr	-30 to +100	°C	
Storage temperature		Tstg	-40 to +125	°C	
*3 Isolation voltage		Viso (rms)	2.5	kV	
*4 Soldering temperature		Tsol	260	°C	

 $<sup>\!\!^*1</sup>$  The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig.2 to 5

# High Sensitivity Type Half Pitch Photocoupler





<sup>\*2</sup> Pulse width≤100µs, Duty ratio=0.001(shown in Fig.6)

<sup>\*3 40</sup> to 60% RH, AC for 1 min, f=60Hz

<sup>\*4</sup> For 10 s

■ Electro-optical Characteristics (Ta=25°C)									
Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	I <sub>F</sub> =20mA	-	1.2	1.4	V	
	Reverse current		IR	$V_R=4V$	_	ı	10	μΑ	
	Terminal capacitance		Ct	V=0, f=1kHz	_	30	250	pF	
Output	Collector dark current		Iceo	$V_{CE}=10V$ , $I_{F}=0$	-	_	1000	nA	
	Collector-emitter breakdown voltage		BVCEO	Ic=0.1mA, I <sub>F</sub> =0	35	-	-	V	
	Emitter-collector breakdown voltage		BVECO	$I_E=10\mu A, I_F=0$	6	_	_	V	
Transfer characteristics	Collector current		Ic	$I_F=1mA$ , $V_{CE}=2V$	6	16	75	mA	
	Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	I <sub>F</sub> =1mA, I <sub>C</sub> =2mA	_	0.8	1.0	V	
	Isolation resistance		Riso	DC500V, 40 to 60%RH	5×1010	1011	_	Ω	
	Floating capacitance		Cf	V=0, f=1MHz	_	0.6	1.0	pF	
	Response time	Rise time	tr	V <sub>CE</sub> =2V I <sub>C</sub> =2mA	_	60	300	μs	
		Fall time	tf	$R_{L}=100\Omega$	_	53	250	μs	

Fig.1 Forward Current vs. Ambient Temperature

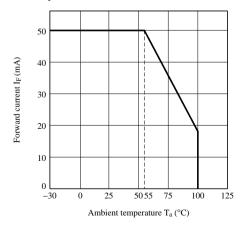
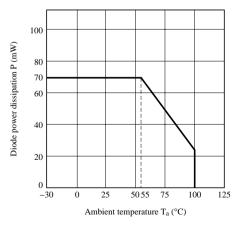


Fig.2 Diode Power Dissipation vs. Ambient Temperature



**PC3H5** 

Fig.3 Collector Power Dissipation vs. Ambient Temperature

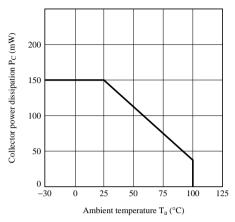


Fig.5 Peak Forward Current vs. Duty Ratio

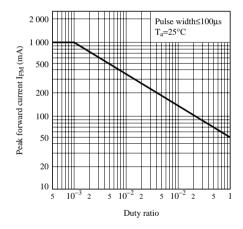
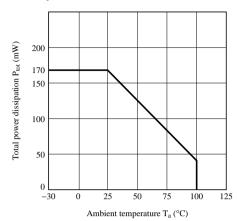


Fig.4 Total Power Dissipation vs. Ambient Temperature



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